

# MOS INTEGRATED CIRCUIT $\mu$ PD16858B/C

# THREE-PHASE SPINDLE MOTOR DRIVER FOR MONOLITHIC CD-ROM

#### DESCRIPTION

The  $\mu$ PD16858B/C is a three-phase spindle motor driver for CD-ROM drives and consists of a CMOS control circuit and a MOS bridge output.

This motor driver employs a three-phase full-wave PWM driving method. Because it has an output stage consisting of MOS FETs, the motor driver consumes less power than the existing linear drivers using bipolar transistors.

The product is supplied in the form of a small, slim 30-pin shrink SOP.

This spindle motor driver is ideal for driving slim-type spindle motors in notebook PCs and so on.

#### **FEATURES**

- Both normal PWM type (16858B) and synchronous rectification PWM type (16858C) are available.
- Low ON resistance (sum of ON resistances of upper and lower MOS FETs):  $Ro_N = 0.8 \Omega$  (TYP)
- · Low power consumption to three-phase full-wave PWM driving
- START/STOP pin is provided. Brake is applied in STOP mode.
- · Standby pin is provided. Internal circuitry is turned off in standby mode.
- Low current consumption: IDD = 3 mA (MAX), IDD (ST) = 1  $\mu$ A (MAX), torque command current = 30  $\mu$ A (MAX)
- · Thermal shut-down circuit and current-limiting circuit
- Low-voltage malfunctioning prevention circuit
- FG output function
- Reverse rotation prevention circuit
- Hole bias function
- 30-pin shrink SOP (300 mil)

#### **ORDERING INFORMATION**

| Part Number     | Package                                    |
|-----------------|--|
| μPD16858BGS-GJG | 30-pin shrink SOP (0.65-mm pitch, 300 mil) |
| μPD16858CGS-GJG | 30-pin shrink SOP (0.65-mm pitch, 300 mil) |

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

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#### **ABSOLUTE MAXIMUM RATINGS**

(T<sub>A</sub> = 25 °C, 1  $\Omega$ /1 mH load condition: mounted on glass epoxy substrate measuring 100 mm  $\times$  100  $mm \times 1$  mm with 15% of copper foil)

| Parameter   | Symbol      | Condition              | Rating                        | Unit    |
|---|-------------|------------------------|-------------------------------|---------|
| ·Supply voltage   | VDD         |                        | -0.5 to +5.7                  | ٧       |
|   | Vм          |                        | -0.5 to +5.7                  | ٧       |
| Input voltage   | Vin         |                        | -0.5 to V <sub>DD</sub> + 0.5 | V       |
| Steady-state DC output currentNote 1                        | In (DC)     | DC                     | ±0.5                          | A/phase |
| Steady-state instantaneous output current <sup>Note 2</sup> | D (pulse)   | PW ≤ 5 ms, Duty ≤ 30 % | ±1.3                          | A/phase |
| Output current at reverse brake <sup>Note 3</sup>           | IDR (pulse) | PW ≤ 5 ms, Duty ≤ 30 % | ±1.5                          | A/phase |
| Power consumption   | Рт          |                        | 1.0                           | ∂: W    |
| Peak joint temperature                                      | Тон (мах)   |                        | 150                           | ∵°C     |
| Storage temperature range                                   | Tetg        |                        | -55 to +150                   | °°C     |

Notes 1. Rated current at constant-speed revolution

- 2. Rated current on starting or locking
- 3. Rated current at reverse brake

#### RECOMMENDED OPERATING CONDITIONS

 $(T_A = 25 \, ^{\circ}\text{C}, 1 \, \Omega/1 \, \text{mH})$  load condition: mounted on glass epoxy substrate measuring 100 mm  $\times$  100  $mm \times 1$  mm with 15% of copper foil)

| Parameter   | Symbol        | MIN.       | TYP. | MAX. | Unit    |
|---|---------------|------------|------|------|---------|
| Supply voltage                                    | Vdd           | 4.5        |      | 5.5  | V       |
|   | Vм            | 4.5        |      | 5.5  | V -     |
| Steady-state DC output currentNote 1              | lo (DC)       |            |      | ±0.4 | A/phase |
| Steady-state instantaneous output currentNote 2   | D (pulse)     | - <u> </u> |      | ±1.0 | A/phase |
| Output current at reverse brake <sup>Note 3</sup> | · IDR (pulse) |            |      | ±1.2 | A/phase |
| Hole bias current                                 | Інв           |            | 10   | 20   | mA -    |
| IND pin output current                            | lFa           | . 0        | ±2.5 | ±5   | mA      |
| Operating temperature range                       | TA            | -20        |      | 75   | °C -    |

Notes 1. Recommended maximum current at constant-speed revolution

- 2. Recommended maximum current on starting or locking (It is recommended that the current be limited to 1.0 A or less.)
- 3. Recommended maximum current at reverse brake

# ELECTRICAL SPECIFICATIONS (Unless otherwise specified, $T_A = 25$ °C, $V_{DD} = V_M = 5$ V)

| Parameter                                | Symbol        | Condition                      | MIN.                 | TYP. | MAX. | Unit |
|--|---------------|--------------------------------|----------------------|------|------|------|
| [Overall]                                |               |                                |                      |      | -    |      |
| Current consumption 1 (during operation) | loo           | STB = VDD                      |                      |      | 3.0  | mA   |
| Current consumption (in standby mode)    | loo (st)      | STB = GND                      |                      |      | 1.0  | μΑ   |
| [ST/SP, STB, REV]                        |               |                                |                      |      |      |      |
| High-level input voltage                 | Vн            |                                | 0.6 V <sub>DD</sub>  |      | VDD  | ٧    |
| Low-level input voltage                  | VıL           |                                |                      |      | 0.8  | . V  |
| Input pull-down resistor                 | RIND          |                                |                      | 120  | ***  | kΩ   |
| [Control circuit]                        |               |                                |                      |      |      |      |
| Triangular wave oscillation frequency    | .fpwм         | Ст = 100 pF                    |                      | 75   |      | kHz  |
| [Hole amplifier]                         |               |                                |                      | ŧ    | ٠.   |      |
| In-phase input voltage range             | VHoh          |                                | 1.5                  |      | 3.5  | V    |
| Hysteresis voltage                       | VHhis         | VH = 2.5 V                     |                      | 15   | .* . | mV.  |
| Input bias current                       | Hbias         |                                |                      |      | 1.0  | μА   |
| [Hole bias block]                        |               |                                |                      |      |      |      |
| Hole bias voltage                        | <b>V</b> нв   | Iнв = 10 mA                    |                      | 0.3  | 0.5  | ٧    |
| [FG output]                              |               |                                | ***                  |      | -    |      |
| IND pin high-level voltage               | Vға_н         | Ifa = -2.5 mA                  | V <sub>DD</sub> -1.0 |      |      | V    |
| IND pin low-level voltage                | VFQ_L         | IFa = +2.5 mA                  |                      |      | 0.5  | ٧    |
| [Output block]                           | ٠             |                                |                      |      |      |      |
| Output ON resistance                     | Ron           | lon = 200 mA                   |                      | 0.8  | 1.2  | Ω    |
| (upper + lower)                          |               | T <sub>A</sub> = -20 to +75 °C |                      |      | 2 .  |      |
| OFF leakage current                      | D (OFF)       |                                |                      |      | 10   | μΑ   |
| Output turn-on time                      | tonh .        | $R_M = 5 \Omega$               |                      |      | 1.0  | μs   |
| Output turn-off time                     | <b>t</b> offh | Star wiring                    |                      | 5    | 1.0  | μs   |
| [Torque command]                         |               |                                |                      | *-   |      |      |
| Control reference input voltage range    | ECR           |                                | 0.3                  |      | 4.0  | ٧    |
| Control input voltage range              | EC            |                                | 0.3                  |      | 4.0  | ٧    |
| Input current                            | In            | EC, ECR = 0.5 to 3 V           |                      |      | 30   | μΑ   |
| Input voltage difference                 | ECR-ECNote    | DUTY = 100 %, ECR = 2.0 V      |                      | 1.1  |      | ٧    |
| DEAD ZONE (+)                            | EC_d+         | ECR = 2.0 V                    | 0                    |      | 100  | m∨   |
| DEAD ZONE (-)                            | EC_d-         | ECR = 2.0 V                    | 0                    |      | -100 | mV   |
| [Overcurrent detector]                   |               |                                |                      |      | ,    |      |
| Input offset voltage                     | Vio           |                                | -15                  |      | +15  | mV   |
| CL pin voltage                           | <b>V</b> cL   |                                |                      | 100  |      | mV   |

Note Excluding the dead zone.

The overheating protection circuit (T.S.D) operates at  $T_{CH} > 150$  °C.

The low-voltage malfunctioning prevention circuit (UVLO) operates at 4 V (TYP).

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#### **PIN FUNCTION**

Package: 30-pin shrink SOP (300 mil)

| IND □            | 1 <b>O</b> | 30 🗖 EC      |
|------------------|------------|--------------|
| STB ⊏            | 2          | 29 🗀 ECR     |
| Vm □             | 3          | 28 🗀 Vod     |
| Vm 🗀             | 4          | 27 🗀 CT      |
| OUT2             | 5          | 26 🗀 H2+     |
| RF□              | 6          | 25 🗀 H2-     |
| RF 🗀             | 7          | 24 🗀 H1+     |
| OUT1 🗀           | 8          | 23 🗀 H1–     |
| V <sub>M</sub> □ | 9          | 22 🗀 H0+     |
| V <sub>M</sub>   | 10         | 21 🗀 H0-     |
| OUT0 🗖           | 11         | 20 🗀 HB      |
| RF 🗀             | 12         | 19 🗀 GND     |
| RF <u></u>       | 13         | 18 🗀 GND     |
| ISEN             | 14         | - 17 🗀 ST/SP |
| CL 🗀             | 15         | 16 🗀 REV     |
| 1                | <u> </u>   | لسبيس        |

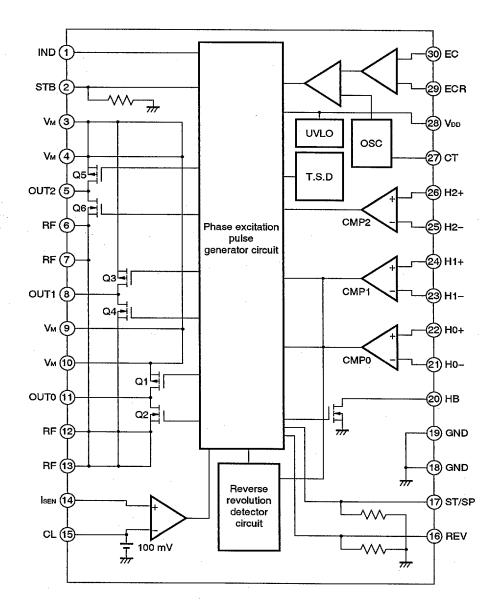
| Pin No | Pin Name        | Pin Function   |
|--------|-----------------|--|
| 1      | IND             | Index signal output pin                                |
| 2      | STB             | Standby operation input pin                            |
| 3      | Vм              | Motor block supply voltage input pin                   |
| 4      | Vм              | Motor block supply voltage input pin                   |
| 5      | OUT2            | Motor connection pin                                   |
| 6      | RF              | Three-phase bridge common pin                          |
| 7      | RF              | Three-phase bridge common pin                          |
| 8      | OUT1            | Motor connection pin                                   |
| 9      | VM              | Motor block supply voltage input pin                   |
| 10     | Vм              | Motor block supply voltage input pin                   |
| 11     | OUT0            | Motor connection pin                                   |
| 12     | RF              | Three-phase bridge common pin                          |
| 13     | RF              | Three-phase bridge common pin                          |
| 14     | Isen            | Sense resistor connection pin                          |
| 15     | CL              | Overcurrent detection voltage filter pin               |
| 16     | REV             | Reverse operation input pin                            |
| 17     | ST/SP           | Start/stop input pin                                   |
| 18     | GND             | GND pin  |
| 19     | GND             | GND pin  |
| 20     | НВ              | Hole bias pin  |
| 21     | H0-             | Hole signal input pin                                  |
| 22     | H0+             | Hole signal input pin                                  |
| 23     | H1-             | Hole signal input pin                                  |
| 24     | H1+             | Hole signal input pin                                  |
| 25     | H2-             | Hole signal input pin                                  |
| 26     | H2+             | Hole signal input pin                                  |
| 27     | Ст              | Oscillation frequency setting capacitor connection pin |
| 28     | V <sub>DD</sub> | Control system supply voltage input pin                |
| 29     | ECR             | Control reference voltage input pin                    |
| 30     | EC              | Control voltage input pin                              |

**Remark** Where more than one pin with the same name exists (such as V<sub>M</sub>, RF, and GND), connect all of them, not just one of them.

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#### **BLOCK DIAGRAM**



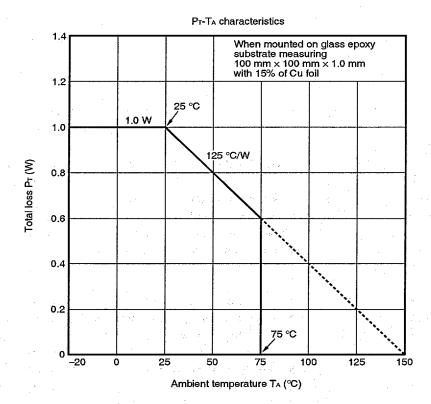
Remarks 1. The CL pin is used to connect a filter. Leave this pin open when it is not used.

2. Where more than one pin with the same name exists (such as V<sub>M</sub>, RF, and GND), connect all of them, not just one of them.

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#### **TOTAL LOSS VS AMBIENT TEMPERATURE CHARACTERISTICS**



Caution If the ambient temperature is 25 °C or less, a power of up to 1 W can be applied. If the temperature rises beyond 25 °C, perform derating by referring to the above figure. At 75 °C, which is the maximum level of the recommended operating temperature, a power of up to 0.6 W can be applied to the IC.

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#### **FUNCTION OPERATION TABLE**

#### (1) ST/SP = "H"

|      | Input Signal |      |     | Circuit Operation Mode | Source → Sink     |
|------|--------------|------|-----|------------------------|-------------------|
| CMP0 | CMP1         | CMP2 | PWM |                        |                   |
| Н    | Н            | L    | Н   | Operate                | $V \rightarrow V$ |
| Н    | Н            | L    | L   | Brake                  |                   |
| Н    | L            | L    | н   | Operate                | W → U             |
| Н    | L            | L    | L   | Brake                  |                   |
| Н    | L            | Н    | н   | Operate                | V → U             |
| Н    | L            | Н    | L   | Brake                  |                   |
| L    | L            | Н    | н   | Operate                | $V \rightarrow W$ |
| L    | L            | Н    | L   | Brake                  |                   |
| L    | Н            | Н    | н   | Operate                | $U \rightarrow W$ |
| L    | Н            | Н    | L   | Brake                  |                   |
| L    | н            | L    | н   | Operate                | $U \rightarrow V$ |
| L    | н            | L    | L   | Brake                  |                   |

Brake: Regenerated via parasitic diode of high-side Pch MOS FET ( $\mu$ PD16858B). Regenerated via high-side Pch MOS FET channel ( $\mu$ PD16858C).

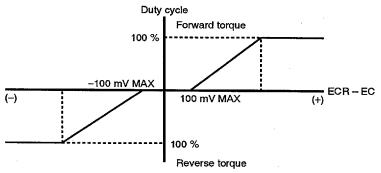
#### (2) ST/SP = "L"

|      | Input : | Circuit Operation Mode |     |             |
|------|---------|------------------------|-----|-------------|
| CMP0 | CMP1    | CMP2                   | PWM |             |
|      | -       | _                      | -   | Short brake |

Short brake: High-side MOS FET turns ON and low-side MOS FET turns OFF.

#### (3) Torque command

The relation between the difference between the control reference voltage (ECR) and control voltage (EC) (ECR – EC) and torque is as follows:



|          | Reverse Pin             | Voltage (REV)           |
|----------|-------------------------|-------------------------|
|          | L                       | H ·                     |
| ECR > EC | Forward                 | Reverse <sup>Note</sup> |
| ECR < EC | Reverse <sup>Note</sup> | Stop                    |

Note Stops if reverse revolution is detected. During reverse revolution, the counter electromotive current flows through the parasitic diode of the Pch MOS FET at the high side ( $\mu$ PD16858B), or the channel of Pch MOS FET at the high side ( $\mu$ PD16858C).

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#### (4) Standby mode

The power supplied to the internal circuitry of the IC can be turned off by setting the IC in the standby mode. In the standby mode, each pin goes into a high-impedance state (H bridge all OFF). The internal oscillation block also stops and therefore, the circuit current can be decreased.

If the motor driver is stopped by using the standby pin while the driver is operating, the motor is stopped by force of inertia. It takes the motor driver about several 10  $\mu$ s to start when it is set in the normal operation mode.

| STB Pin | Operation Mode |
|---------|----------------|
| Н       | Normal mode    |
| L       | Standby mode   |

#### **Caution Output current**

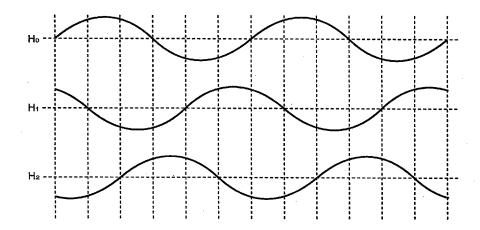
The rated output current differs depending on whether the motor revolves at a constant speed (steady state), is started (steady state), or reversed and brake is applied. The rated DC current when the motor revolves at a constant speed is 0.5 A, and the rated instantaneous current when the motor is started is 1.3 A. When brake is applied to stop the motor and when the motor is reversed, the maximum current is 1.5 A.

When a brake is applied or the motor is reversed, a current exceeding that when the motor revolves at a constant speed (immediately before a brake is applied) instantaneously flows because of the counter electromotive force due to the motor inductance. Determine the value of overcurrent for the steady state, taking the peak current for reversing or applying a brake to the motor into consideration.

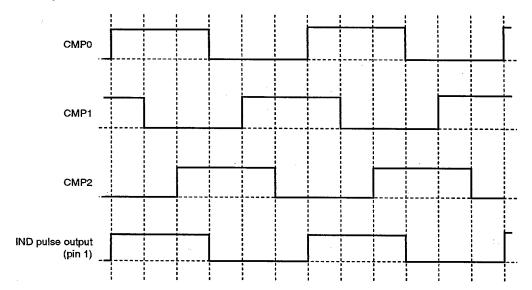
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#### **TIMING CHARTS**

#### (1) Hole signal input



#### (2) CMP signal



# (3) Output MOS FET driving and comparator selection (blank: switch OFF)

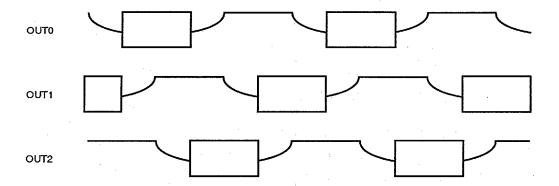
| Q1 |      | (SW) | (SW) |                   | ON   | ON   |                   | (SW) | ( <del>SW</del> ) |      | ON   | ON   |      |
|----|------|------|------|-------------------|------|------|-------------------|------|-------------------|------|------|------|------|
| Q2 |      | sw   | sw   |                   |      |      |                   | sw   | sw                |      |      |      | ·    |
| QЗ | (SW) |      | ON   | ON                |      | (SW) | ( <del>SW</del> ) |      | ON                | ON   |      | (SW) | (SW) |
| Q4 | sw   |      |      |                   |      | sw   | sw                |      |                   |      |      | sw   | sw   |
| Q5 | ON   | ON   |      | ( <del>SW</del> ) | (SW) |      | ON                | ON   |                   | (SW) | (SW) |      | ON   |
| Q6 |      |      |      | sw                | sw   |      |                   |      |                   | sw   | sw   |      |      |

The high-side MOS FET at the output stage of the  $\mu$ PD16858C performs synchronous switching (switching in parentheses).

The high-side MOS FET of the  $\mu$ PD16858B does not perform switching in parentheses but is in the OFF state.

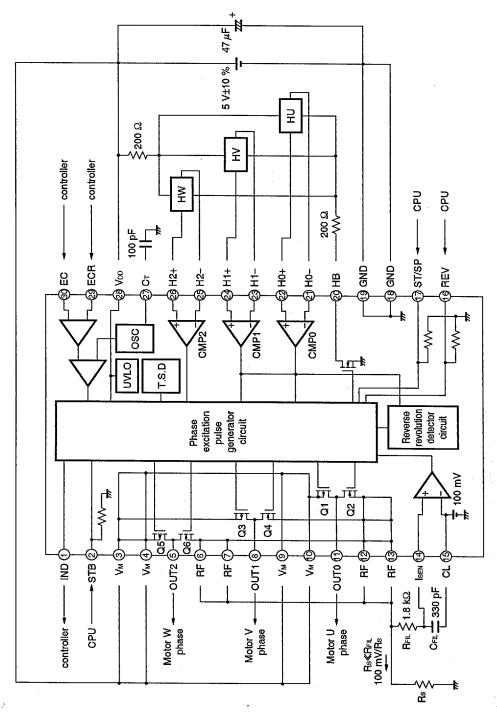
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### (4) Motor driving wave



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#### **APPLICATION CIRCUIT EXAMPLE**



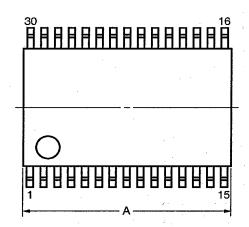
Caution It is recommended that a tantalum capacitor of several 10  $\mu$ F be inserted between V<sub>M</sub> and GND to reduce noise during PWM. Determine the value of Rs so that the output current does not exceed the rating.

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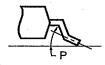
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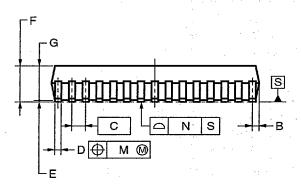
#### **PACKAGE DRAWING**

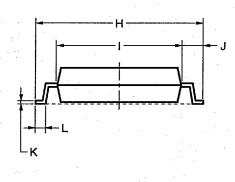
# 30 PIN PLASTIC SHRINK SOP (300 mil)



detail of lead end







#### NOTES

- 1. Controlling dimension millimeter.
- 2. Each lead centerline is located within 0.10 mm (0.004 inch) of its true position (T.P.) at maximum material condition.

| ITEM | MILLIMETERS                     | INCHES       |
|------|---------------------------------|--------------|
| Α    | 9.85±0.26                       | 0.388±0.011  |
| . В  | 0.51 MAX.                       | 0.020 MAX.   |
| С    | 0.65 (T.P.)                     | 0.026 (T.P.) |
| D    | 0.32+0.08                       | 0.013+0.003  |
| E    | 0.125±0.075                     | 0.005±0.003  |
| F    | 2.0 MAX.                        | 0.079 MAX.   |
| G    | 1.7±0.1                         | 0.067±0.004  |
| Н    | 8.1±0.2                         | 0.319±0.008  |
| ı    | 6.1±0.2                         | 0.240±0.008  |
| J    | 1.0±0.2                         | 0.039+0.009  |
| К    | 0.17 <del>+</del> 0.08<br>-0.07 | 0.007+0.003  |
| L    | 0.5±0.2                         | 0.020+0.008  |
| М    | 0.10                            | 0.004        |
| N    | 0.10                            | 0.004        |
| Р    | 3° <del>-</del> 3°              | 3°+7°        |

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#### RECOMMENDED SOLDERING CONDITONS

Solder this product under the following recommended conditions.

For details of the recommended soldering conditions, refer to information document **Semiconductor Device Mounting Technology Manual (C10535E)**.

For soldering methods and conditions other than those recommended, consult NEC.

| Soldering Method(s) | Soldering Conditions  | Recommended<br>Conditions Symbol |
|---------------------|---|----------------------------------|
| Infrared reflow     | Package peak temperature: 235 °C, Time: 30 sec max. (210 °C min.), Number of times: three times max., Number of days: None <sup>Note</sup> , Flux: Rosin-based flux with little chlorine content (chlorine: 0.2 Wt% max.) is recommended. | IR35-00-3                        |
| VPS                 | Package peak temperature: 215 °C, Time: 40 sec max. (200 °C min.), Number of times: three times max., Number of days: None <sup>Note</sup> , Flux: Rosin-based flux with little chlorine content (chlorine: 0.2 Wt% max.) is recommended. | VP15-00-3                        |
| Wave soldering      | Package peak temperature: 260 °C, Time: 10 sec max., Preheating temperature: 120 °C max., Number of times: once, Flux: Rosin-based flux with little chlorine content (chlorine: 0.2 Wt% max.) is recommended.                             | WS60-00-1                        |

Note Number of days in storage after the dry pack has been opened. The storage conditions are at 25  $^{\circ}$ C, 65% RH MAX.

Caution Do not use two or more soldering methods in combination.

[MEMO]

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[MEMO]

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